FDB8443_F085 N-Channel PowerTrench[®] MOSFET FAIRCHILD Sep 2011 SEMICONDUCTOR® FDB8443_F085 N-Channel PowerTrench[®] MOSFET **40V, 80A, 3.0m**Ω **Applications Features** Typ $r_{DS(on)}$ = 2.3m Ω at V_{GS} = 10V, I_D = 80A Automotive Engine Control ■ Typ Q_{q(10)} = 142nC at V_{GS} = 10V Powertrain Management Solenoid and Motor Drivers ■ Low Miller Charge ■ Low Q_{rr} Body Diode Electronic Steering ■ UIS Capability (Single Pulse and Repetitive Pulse) Integrated Starter / Alternator Qualified to AEC Q101 Distributed Power Architecture and VRMs RoHS Compliant Primary Switch for 12V Systems ROHS D GATE DRAIN SOURCE (FLANGE) TO-263AB FDB SERIES

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain to Source Voltage		40	V
V _{GS}	Gate to Source Voltage		±20	V
	Drain Current Continuous (T _C < 146 ^o C, V _{GS} = 10V)		80	
I _D	Continuous (T_{amb} = 25°C, V_{GS} = 10V, with $R_{\theta JA}$ = 43°C/W)		25	Α
	Pulsed		See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (N	ote 1)	531	mJ
D	Power Dissipation		188	W
PD	Derate above 25°C		1.25	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to +175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case		0.8	°C/W
R_{\thetaJA}	Thermal Resistance Junction to Ambient	(Note 2)	62	°C/W
R_{\thetaJA}	Thermal Resistance Junction to Ambient TO-263, 1in ² copper pad	area	43	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8443	FDB8443_F085	TO-263AB	330mm	24mm	800 units

Electrical Characteristics T_{C} = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

Off Characteristics

B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS}	= 0V	40	-	-	V
	Zara Cata Valtaga Drain Current	V _{DS} = 32V,		-	-	1	
I _{DSS} Zero Gate Voltage Drain Current	$V_{GS} = 0V$	T _C = 150 ^o C	-	-	250	μA	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V		-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.8	4	V
		I _D = 80A, V _{GS} = 10V	-	2.3	3.0	
r _{DS(on)}	Drain to Source On Resistance	$I_D = 80A, V_{GS} = 10V, T_J = 175^{\circ}C$	-	4.2	5.5	mΩ

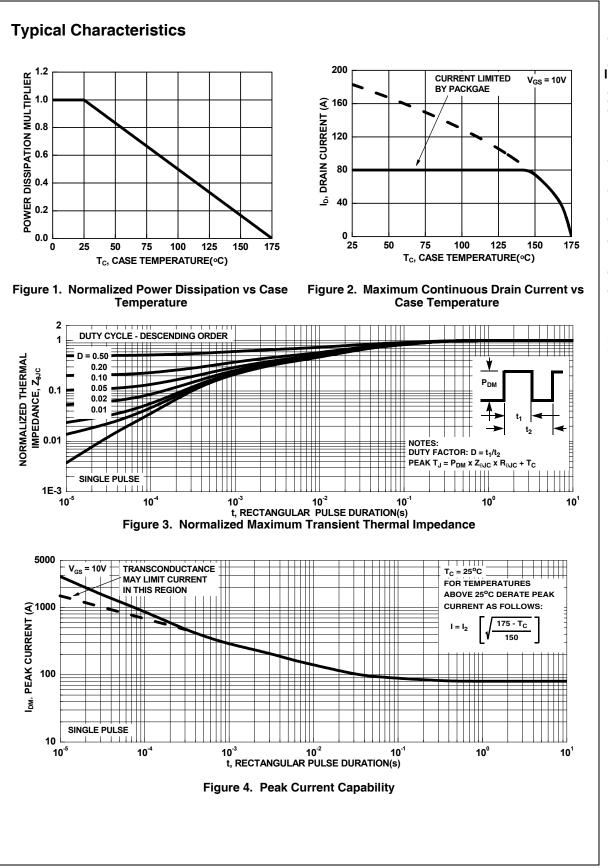
Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	9310	-	pF
C _{oss}	Output Capacitance			-	800	-	pF
C _{rss}	Reverse Transfer Capacitance			-	510	-	pF
R _G	Gate Resistance	V _{GS} = 0.5V, f = 1M	Hz	-	0.9	-	Ω
Q _{g(TOT)}	Total Gate Charge at 10V	V_{GS} = 0 to 10V		-	142	185	nC
Q _{g(TH)}	Threshold Gate Charge	V_{GS} = 0 to 2V	V _{DD} = 20V	-	17.5	23	nC
Q _{gs}	Gate to Source Gate Charge		I _D = 35A	-	36	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		I _g = 1mA	-	18.8	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	32	-	nC

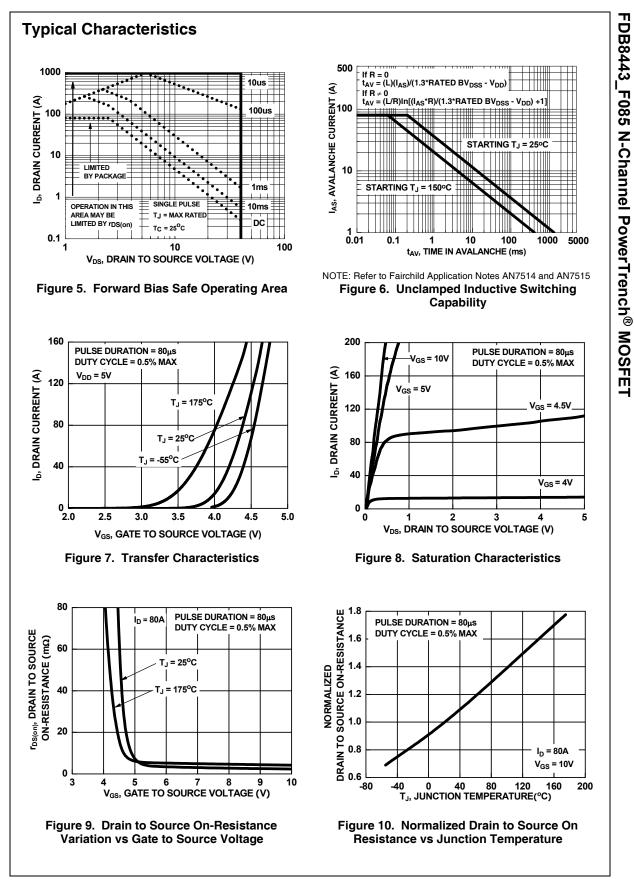
t _{on} ; t _{d(on)} ; t _r ; t _{d(off)} ; t _f ; t _{off} ;	ng Characteristics (V _{GS} Turn-On Time Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Time	= 10V) $V_{DD} = 20V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 2\Omega$		- 18.4 17.9 55	58 - -	ns ns ns
t _{d(on)} t _r t _{d(off)} t _f t _{off}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 20V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 2\Omega$	-	18.4 17.9	-	ns
t _{d(on)} t _r t _{d(off)} t _f t _{off}	Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 20V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 2\Omega$	-	17.9		
t _r t _{d(off)} t _{d(off)} t _f toff	Turn-Off Delay Time Fall Time	$V_{DD} = 20V, I_D = 35A$ 			-	ns
t _{d(off)} t _f t _{off}	Fall Time	\sim V _{GS} = 10V, R _{GS} = 2Ω	-	55		
t _f t _{off}				55	-	ns
t _{off}	Turn-Off Time		-	13.5	-	ns
			-	-	109	ns
	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 35A	-	0.8	1.25	v
V SD	Source to Drain Diode voltage	I _{SD} = 15A	-	0.8	1.0	v
t _{rr} I	Reverse Recovery Time	—I _{SD} = 35A, dI _{SD} /dt = 100A/μs	-	42	55	ns
Q _{rr} I	Reverse Recovery Charge	$I_{SD} = 35A$, $dI_{SD}/dt = 100A/\mu s$	-	48	62	nC

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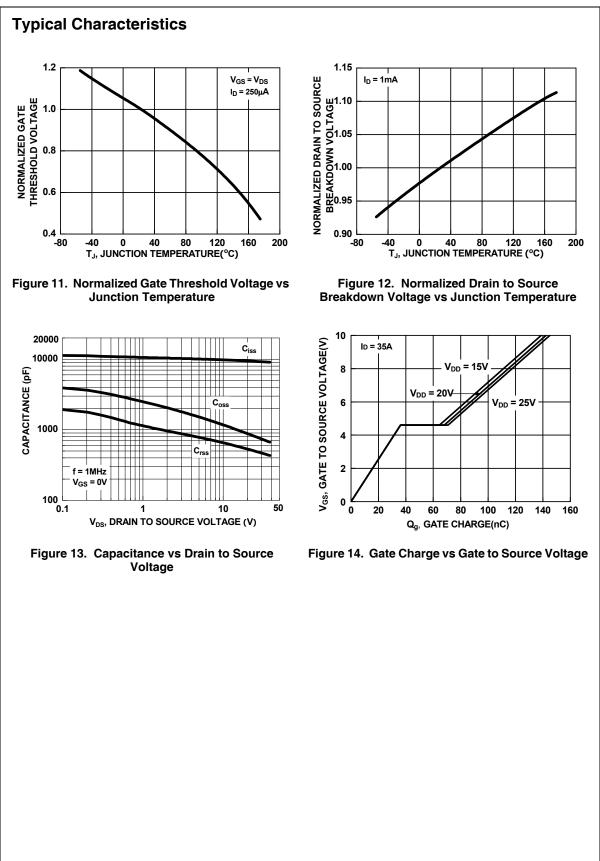
certification.



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